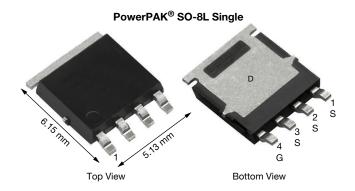


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Vishay Siliconix

# Automotive N-Channel 80 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY			
V <sub>DS</sub> (V)	80		
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0076		
I <sub>D</sub> (A)	60		
Configuration	Single		
Package	PowerPAK SO-8L		

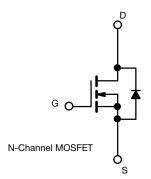
#### **FEATURES**

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912





ROHS COMPLIANT HALOGEN FREE



PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	80	V	
Gate-source voltage		$V_{GS}$	± 20		
Continuous drain current	T <sub>C</sub> = 25 °C	1	60		
	T <sub>C</sub> = 125 °C	I <sub>D</sub>	37		
Continuous source current (diode conduction)		I <sub>S</sub>	60	А	
Pulsed drain current <sup>a</sup>		I <sub>DM</sub>	160		
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	34		
Single pulse avalanche energy	L=0.1 mm	E <sub>AS</sub>	57	mJ	
Maximum power dissipation <sup>a</sup>	T <sub>C</sub> = 25 °C	D	68	W	
	T <sub>C</sub> = 125 °C	$P_{D}$	22		
Operating junction and storage temperature range  Soldering recommendations (peak temperature) c, d		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	%0	
			260	°C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB Mount b	$R_{thJA}$	68	°C/W
unction-to-case (drain)		$R_{thJC}$	2.2	C/VV

#### Notes

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. When mounted on 1" square PCB (FR4 material).
- c. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- d. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-source breakdown voltage	$V_{DS}$	V <sub>GS</sub> = 0, I <sub>D</sub> = 250 μA		80	-	-	V	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$		2.5	3.0	3.5	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 80 V	-	-	1		
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 80 V, T <sub>J</sub> = 125 °C	-	-	50	μA	
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 80 V, T <sub>J</sub> = 175 °C	-	-	150		
On-state drain current a	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 \text{ V}$	30	-	-	Α	
Drain-source on-state resistance <sup>a</sup>	=(-:-)	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A	-	0.0063	0.0076	Ω	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A, T <sub>J</sub> = 125 °C	-	-	0.0121		
	Bo(on)	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A, T <sub>J</sub> = 175 °C	-	_	0.0148		
Forward transconductance b		V <sub>DS</sub>	= 15 V, I <sub>D</sub> = 10 A	-	45	-	S	
Dynamic <sup>b</sup>						l	<u>l</u>	
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 25 V, f = 1 MHz	-	2629	3500	pF	
Output capacitance	C <sub>oss</sub>			_	1487	2000		
Reverse transfer capacitance	C <sub>rss</sub>			-	50	70		
Total gate charge <sup>c</sup>	Qq			-	36	55	nC	
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{DS} = 40 \text{ V}, I_{D} = 5 \text{ A}$	_	10	-		
Gate-drain charge c	Q <sub>gd</sub>	1		-	6	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz		0.18	0.39	0.62	Ω	
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>	$V_{DD} = 40 \text{ V}, \text{ R}_L = 8 \Omega$ $I_D \cong 5 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		-	16	25	ns	
Rise time <sup>c</sup>	t <sub>r</sub>			_	5	10		
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>			_	26	40		
Fall time <sup>c</sup>	t <sub>f</sub>			_	19	30		
Source-Drain Diode Ratings and Charac	teristics b			L	1		l	
Pulsed current <sup>a</sup>	I <sub>SM</sub>	T		-	_	160	Α	
Forward voltage	V <sub>SD</sub>	I <sub>F</sub> = 10 A, V <sub>GS</sub> = 0		-	0.8	1.5	V	
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 10 A, di/dt = 100 A/μs		-	64	130	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>			-	108	220	nC	
Reverse recovery fall time	t <sub>a</sub>			-	31	-		
Reverse recovery rise time	t <sub>b</sub>			-	34		ns	
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-3.1	-6	Α	

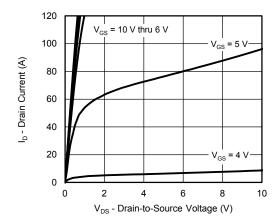
#### **Notes**

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

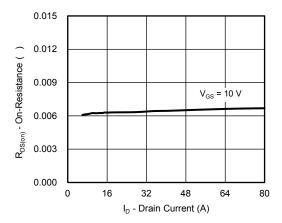
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



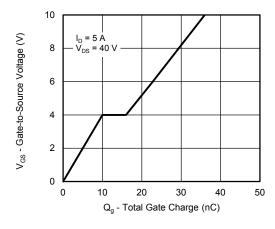
### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



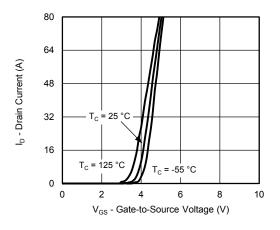
#### **Output Characteristics**



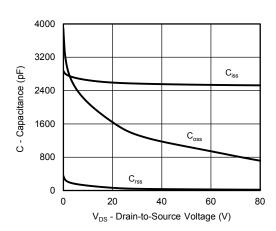
On-Resistance vs. Drain Current



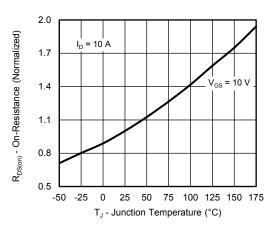
**Gate Charge** 



**Transfer Characteristics** 



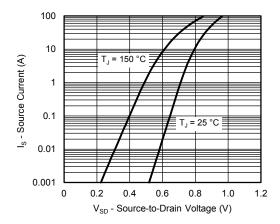
Capacitance



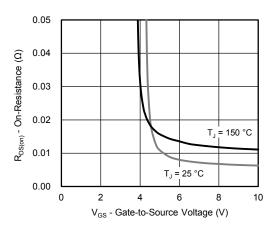
On-Resistance vs. Junction Temperature



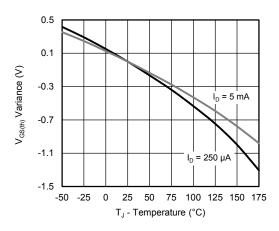
## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



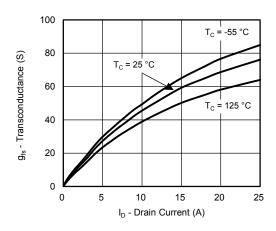
**Source Drain Diode Forward Voltage** 



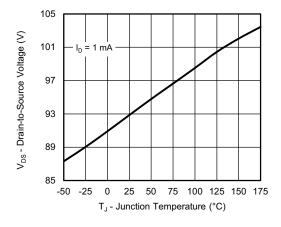
On-Resistance vs. Gate-to Source Voltage



**Threshold Voltage** 



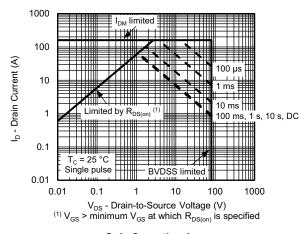
Transconductance



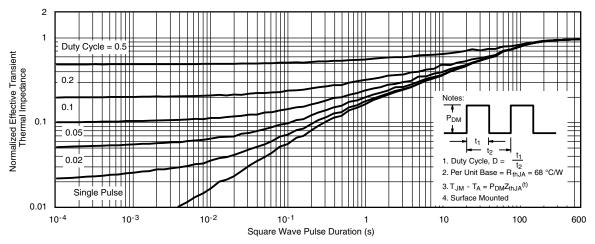
Drain Source Breakdown vs. Junction Temperature



## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



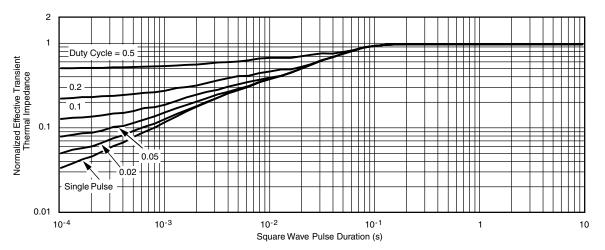
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

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### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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